

Application Specific Discretes A.S.D.<sup>TM</sup>

# ITA6V1U1 TRANSIL™ ARRAY FOR DATALINE PROTECTION

## **APPLICATIONS**

Data transmission lines protection :

- Unipolar signal up to 5.5V
- Bipolar signal in the +/- 2.5V range

#### **FEATURES**

- HIGH SURGE CAPABILITY TRANSIL ARRAY  $I_{PP} = 40 \text{ A} (8/20 \mu s)$
- PEAK PULSE POWER : 300 W (8/20µs)
- UP TO 6 UNIDIRECTIONAL TRANSIL FUNC-TIONS
- LOW CLAMPING FACTOR (V<sub>CL</sub> / V<sub>BR</sub>) AT HIGH CURRENT LEVEL
- LOW LEAKAGE CURRENT
- ESD PROTECTION UP TO 15kV

#### DESCRIPTION

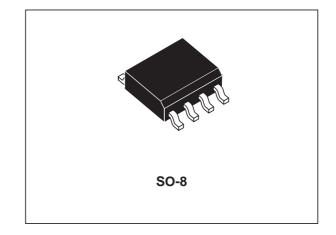
Transil diode arrays provide high overvoltage protection by clamping action. Their instantaneous response to transient overvoltages makes them particularly suited to protect voltage sensitive devices such as MOS Technology and low voltage supplied IC's.

The ITA series allies high surge capability against energetic pulses with high voltage performance against ESD.

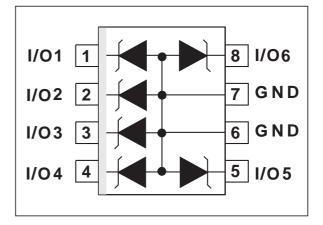
#### COMPLIES WITH THE FOLLOWING STANDARDS :

IEC 1000-4-2 : level 4 IEC 1000-4-4 : level 4 IEC 1000-4-5 : level 2

MIL STD 883C - Method 3015-6 : class 3 (human body model)



### FUNCTIONAL DIAGRAM

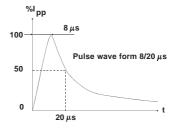


## **ITA6V1U1**

Symbol	Parameter	Value	Unit
P <sub>PP</sub>	Peak pulse power dissipation (8/20µs) (see note 1)	300	W
IPP	Peak pulse current (8/20µs) (see note 1)	40	А
l <sup>2</sup> t	Wire I <sup>2</sup> t value (see note 1)	0.6	A <sup>2</sup> s
T <sub>stg</sub> T <sub>j</sub>	Storage temperature range Maximum operating junction temperature	- 55 to + 150 125	°C ℃
TL	Maximum lead temperature for soldering du	260	°C

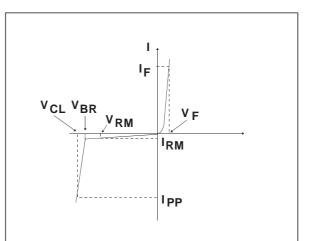
## ABSOLUTE MAXIMUM RATINGS (Tamb = 25°C)

Note 1 : For surges greater than the specified maximum value, the I/O will first present a short-circuit and after an open circuit caused by the wire melting.



## ELECTRICAL CHARACTERISTICS (Tamb = 25°C)

Symbol	Parameter				
V <sub>RM</sub>	Stand-off voltage				
V <sub>BR</sub>	Breakdown voltage				
V <sub>CL</sub>	V <sub>CL</sub> Clamping voltage				
I <sub>RM</sub>	Leakage current @ V <sub>RM</sub>				
IPP	Peak pulse current				
ατ	Voltage temperature coefficient				
С	Junction capacitance				
VF	Forward voltage drop				

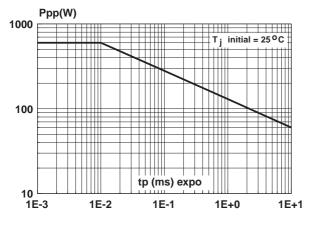


Types	I <sub>RM</sub> @	V <sub>RM</sub>	V <sub>BR</sub>	@ I <sub>R</sub>	V <sub>CL</sub>	@ Ірр	V <sub>CL</sub> (	@ <b>I</b> PP	αΤ	С	V <sub>F</sub> @	) <b>I</b> F
	max.		min.		max.	8/20μ s	max.	8/20μ s	max.	max.	max.	
			note 2		note 2		note 2			note 3		
	μΑ	v	v	mA	v	Α	v	А	10 <sup>-4</sup> /°C	рF	v	Α
ITA6V1U1	10	5	6.1	1	10	10	12	25	4	1500	1.3	1

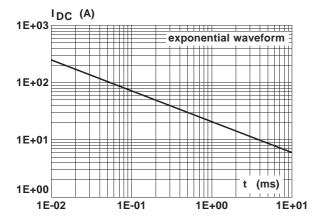
Note 2 : Between I/O pin and ground. Note 3 : Between I/O pin and ground, at 0V Bias. F = 1MHz.

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**Fig. 1 :** Typical peak pulse power versus exponential pulse duration.



**Fig. 3 :** Peak current I<sub>DC</sub> inducing open circuit of the wire for one input/output versus pulse duration (typical values).



**Fig. 5** : Relative variation of leakage current versus junction temperature

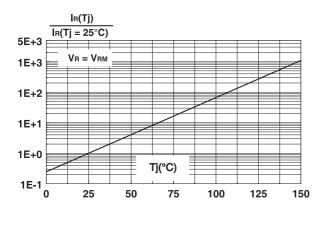
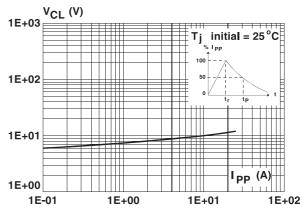
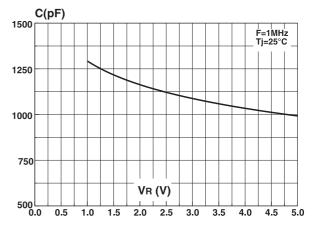


Fig. 2 : Clamping voltage versus peak pulse current (exponential waveform  $8/20 \ \mu s$ ).



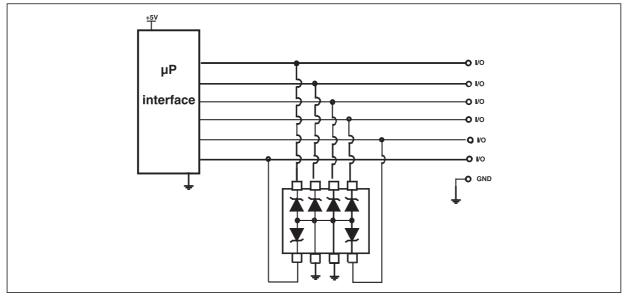
**Fig. 4 :** Junction capacitance versus reverse applied voltage for one input/output (typical values).



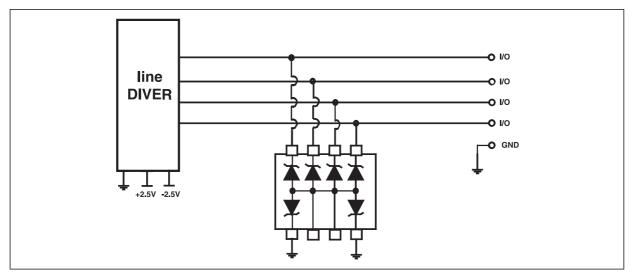
# ITA6V1U1

# **APPLICATION INFORMATION**

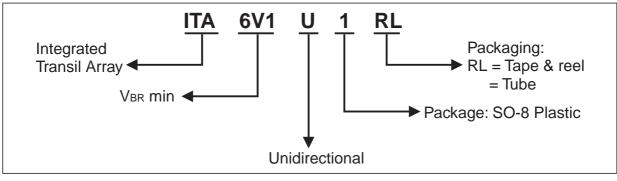
# Typical application 1 : $\mu$ P I/O lines



Typical application 2 : +/-2.5V Data lines



## **ORDER CODE**



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4/5

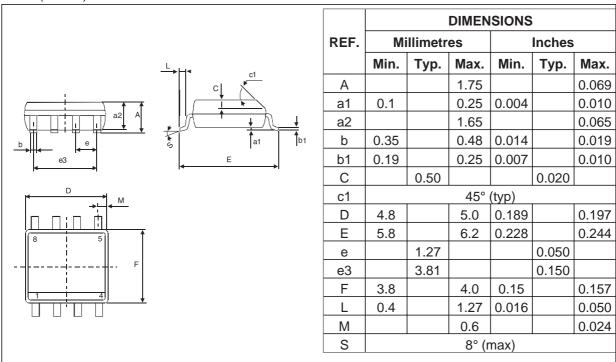
#### MARKING

TYPE	MARKING			
ITA6V1U1	6V1U1			

**Packaging :** Preferred packaging is tape and reel. **Weight** : 0.08g.

## PACKAGE MECHANICAL DATA

SO-8 (Plastic)



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